



# FAN2110 — TinyBuck™, 3-24 V Input, 10 A, High-Efficiency, Integrated Synchronous Buck Regulator

## Features

- Wide Input Voltage Range: 3 V-24 V
- Wide Output Voltage Range: 0.8 V to 80%  $V_{IN}$
- 10 A Output Current
- 1% Reference Accuracy Over Temperature
- Over 93% Peak Efficiency
- Programmable Frequency Operation: 200 KHz to 600 KHz
- Fully Synchronous Operation with Integrated Schottky Diode on Low-Side MOSFET Boosts Efficiency
- Internal Bootstrap Diode
- Power-Good Signal
- Starts up on Pre-Bias Outputs
- Accepts Ceramic Capacitors on Output
- External Compensation for Flexible Design
- Programmable Current Limit
- Under-Voltage, Over-Voltage, and Thermal Shutdown Protections
- Internal Soft-Start
- 5x6 mm, 25-Pin, 3-Pad MLP Package

## Applications

- Servers & Telecom
- Graphics Cards & Displays
- Computing Systems
- Point-of-Load Regulation
- Set-Top Boxes & Game Consoles

## Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FAN2110MPX	-10°C to 85°C	Molded Leadless Package (MLP) 5 x 6 mm	Tape and Reel
FAN2110EMPX	-40°C to 85°C		

### Typical Application

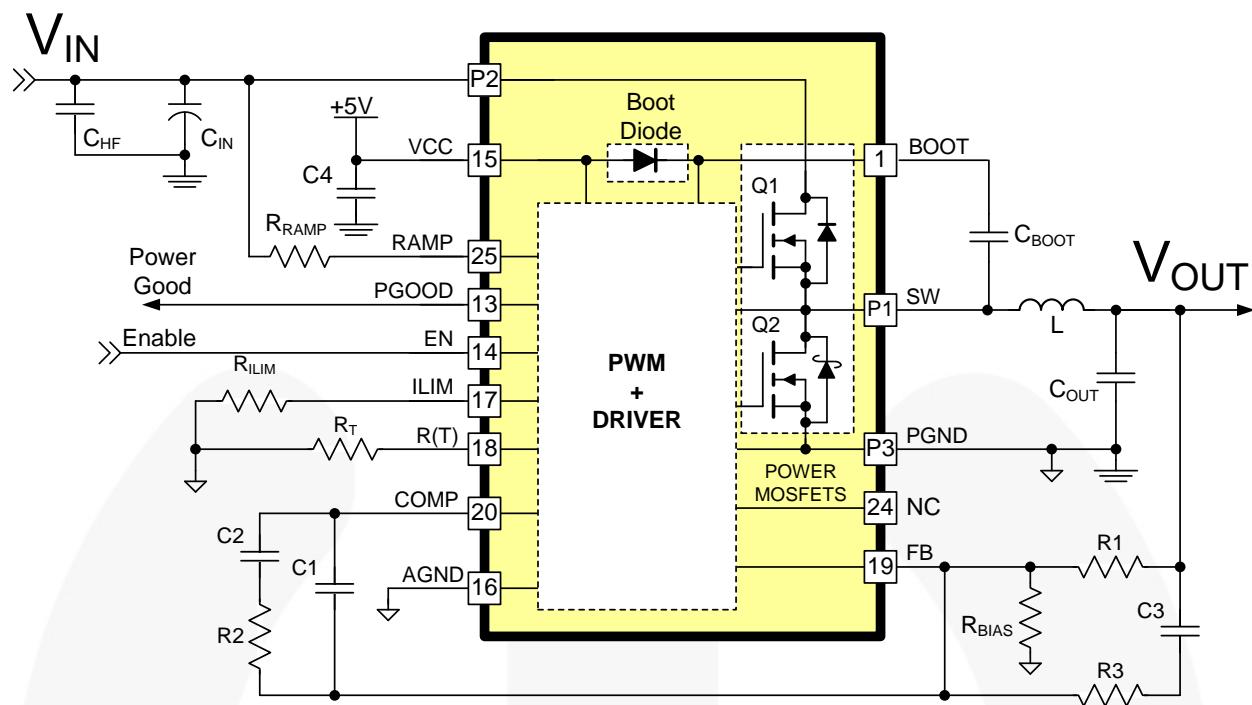


Figure 1. Typical Application Diagram

### Block Diagram

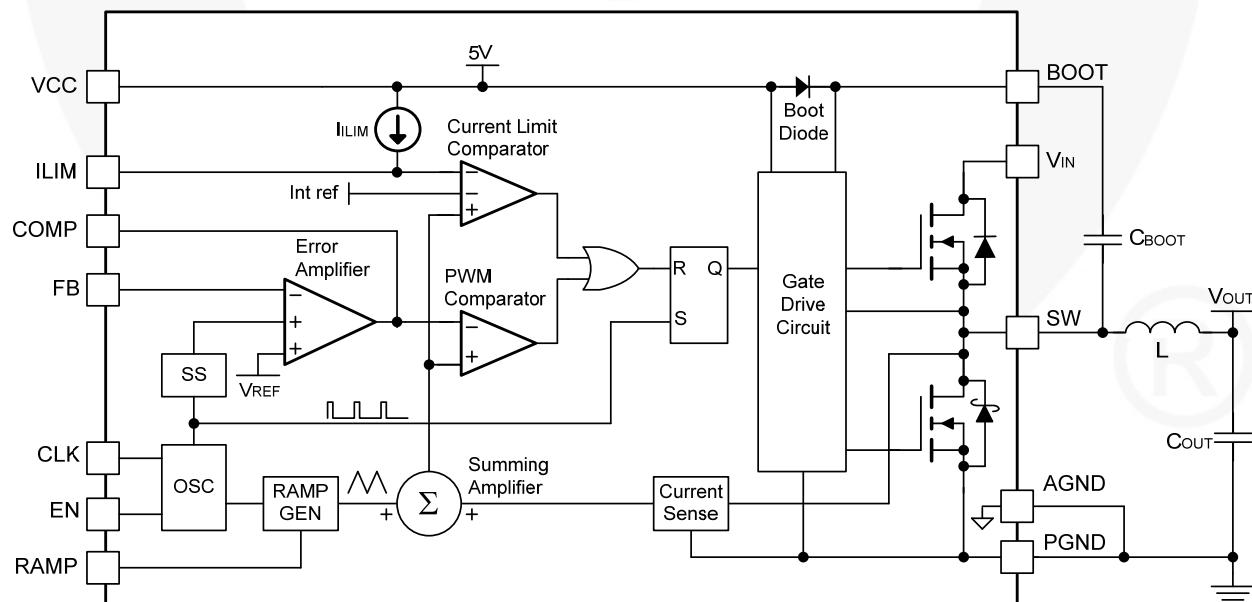
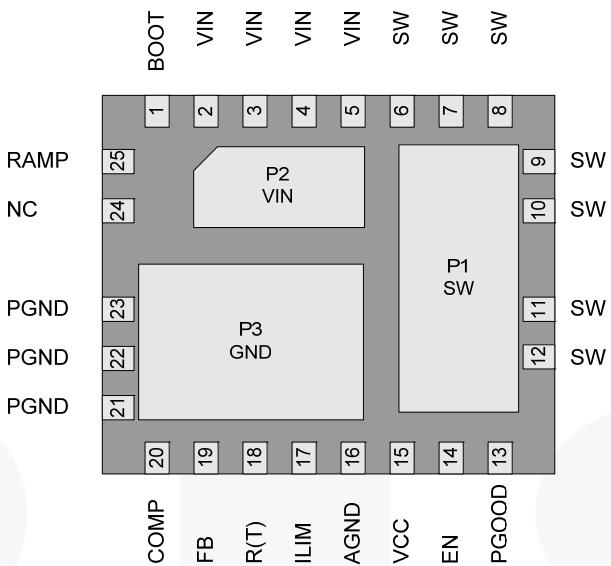


Figure 2. Block Diagram

## Pin Configuration



**Figure 3. MLP 5 x 6 mm Pin Configuration (Bottom View)**

## Pin Definitions

Pin #	Name	Description
P1, 6-12	SW	<b>Switching Node.</b> Junction of high-side and low-side MOSFETs.
P2, 2-5	VIN	<b>Power Conversion Input Voltage.</b> Connect to the main input power source.
P3, 21-23	PGND	<b>Power Ground.</b> Power return and Q2 source.
1	BOOT	<b>High-Side Drive BOOT Voltage.</b> Connect through capacitor ( $C_{BOOT}$ ) to SW. The IC includes an internal synchronous bootstrap diode to recharge the capacitor on this pin to $V_{CC}$ when SW is LOW.
13	PGOOD	<b>Power-Good Flag.</b> An open-drain output that pulls LOW when FB is outside the limits specified in electrical specs. PGOOD does not assert HIGH until the fault latch is enabled.
14	EN	<b>ENABLE.</b> Enables operation when pulled to logic HIGH or left open. Toggling EN resets the regulator after a latched fault condition. This input has an internal pull-up when the IC is functioning normally. When a latched fault occurs, EN is discharged by a current sink.
15	VCC	<b>Input Bias Supply for IC.</b> The IC's logic and analog circuitry are powered from this pin. This pin should be decoupled to AGND through a $> 2.2 \mu F$ X5R / X7R capacitor.
16	AGND	<b>Analog Ground.</b> The signal ground for the IC. All internal control voltages are referred to this pin. Tie this pin to the ground island/plane through the lowest impedance connection.
17	ILIM	<b>Current Limit.</b> A resistor ( $R_{ILIM}$ ) from this pin to AGND can be used to program the current-limit trip threshold lower than the internal default setting.
18	R(T)	<b>Oscillator Frequency.</b> A resistor ( $R_T$ ) from this pin to AGND sets the PWM switching frequency.
19	FB	<b>Output Voltage Feedback.</b> Connect through a resistor divider to the output voltage.
20	COMP	<b>Compensation.</b> Error amplifier output. Connect the external compensation network between this pin and FB.
24	NC	<b>No Connect.</b> This pin is not used.
25	RAMP	<b>Ramp Amplitude.</b> A resistor ( $R_{RAMP}$ ) connected from this pin to $V_{IN}$ sets the ramp amplitude and provides voltage feedforward functionality.

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Parameter	Conditions	Min.	Max.	Unit
VIN to PGND			28	V
VCC to AGND	AGND=PGND		6	V
BOOT to PGND			35	V
BOOT to SW		-0.5	6.0	V
SW to PGND	Continuous	-0.5	24.0	V
	Transient ( $t < 20$ ns, $f \leq 600$ KHz)	-5	30	V
All other pins		-0.3	$V_{CC}+0.3$	V
ESD	Human Body Model, JEDEC JESD22-A114	2.0		KV
	Charged Device Model, JEDEC JESD22-C101	2.5		

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$V_{CC}$	Bias Voltage	VCC to AGND	4.5	5.0	5.5	V
$V_{IN}$	Supply Voltage	VIN to PGND	3		24	V
$T_A$	Ambient Temperature	FAN2110MPX	-10		+85	°C
		FAN2110EMPX	-40		+85	°C
$T_J$	Junction Temperature				+125	°C
$f_{SW}$	Switching Frequency		200		600	kHz

## Thermal Information

Symbol	Parameter	Min.	Typ.	Max.	Unit
$T_{STG}$	Storage Temperature	-65		+150	°C
$T_L$	Lead Soldering Temperature, 10 Seconds			+300	°C
$\theta_{JC}$	Thermal Resistance: Junction-to-Case	P1 (Q2)	4		°C/W
		P2 (Q1)	7		°C/W
		P3	4		°C/W
$\theta_{J-PCB}$	Thermal Resistance: Junction-to-Mounting Surface <sup>(1)</sup>		35		°C/W
$P_D$	Power Dissipation, $T_A=25^\circ\text{C}^{(1)}$			2.8	W

### Note:

1. Typical thermal resistance when mounted on a four-layer, two-ounce PCB, as shown in Figure 35. Actual results are dependent on mounting method and surface related to the design.

## Electrical Specifications

Electrical specifications are the result of using the circuit shown in Figure 1 with  $V_{IN}=12$  V, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>Power Supplies</b>						
$I_{CC}$	$V_{CC}$ Current	SW=Open, $V_{FB}=0.7$ V, $V_{CC}=5$ V, $f_{SW}=600$ KHz		8	12	mA
		Shutdown: EN=0, $V_{CC}=5$ V		7	10	$\mu$ A
$V_{UVLO}$	$V_{CC}$ UVLO Threshold	Rising $V_{CC}$	4.1	4.3	4.5	V
		Hysteresis		300		mV
<b>Oscillator</b>						
$f_{SW}$	Frequency	$R_T=50$ K $\Omega$ to GND	255	300	345	KHz
		$R_T=24$ K $\Omega$ to GND	540	600	660	KHz
$t_{ONmin}$	Minimum On-Time <sup>(2)</sup>			50	65	ns
$V_{RAMP}$	Ramp Amplitude, Peak-to-Peak	16 $V_{IN}$ , 1.8 $V_{OUT}$ , $R_T=30$ K $\Omega$ , $R_{RAMP}=200$ K $\Omega$		0.53		V
$t_{OFFmin}$	Minimum Off-Time <sup>(2)</sup>			100	150	ns
<b>Reference</b>						
$V_{FB}$	Reference Voltage (see Figure 4 for Temperature Coefficient)	$V_{FB}$ = 2.0 V, $25^\circ C$	794	800	806	mV
		$V_{FB}$ = 1.2 V, $25^\circ C$	795	800	805	mV
<b>Error Amplifier</b>						
$G$	DC Gain <sup>(2)</sup>	$V_{CC}=5$ V	80	85		dB
GBW	Gain Bandwidth Product <sup>(2)</sup>		12	15		MHz
$V_{COMP}$	Output Voltage <sup>(2)</sup>		0.4		3.2	V
$I_{SINK}$	Output Current, Sourcing	$V_{CC}=5$ V, $V_{COMP}=2.2$ V	1.5	2.2		mA
$I_{SOURCE}$	Output Current, Sinking	$V_{CC}=5$ V, $V_{COMP}=1.2$ V	0.8	1.2		mA
$I_{BIAS}$	FB Bias Current	$V_{FB}=0.8$ V, $25^\circ C$	-850	-650	-450	nA
<b>Protection and Shutdown</b>						
$I_{LIM}$	Current Limit (see Circuit Description) <sup>(2)</sup>	$R_{ILIM}=182$ K $\Omega$ , $25^\circ C$ , $f_{SW}=500$ KHz, $V_{OUT}=1.5$ V, $R_{RAMP}=243$ K $\Omega$ , 16 Consecutive Clock Cycles <sup>(3)</sup>	12	14	16	A
$I_{ILIM}$	$I_{LIM}$ Current	$V_{CC}=5$ V, $25^\circ C$	-11	-10	-9	$\mu$ A
$T_{TSD}$	Over-Temperature Shutdown <sup>(2)</sup>	Internal IC Temperature		+155		°C
$T_{HYS}$	Over-Temperature Hysteresis <sup>(2)</sup>			+30		°C
$V_{OVP}$	Over-Voltage Threshold	2 Consecutive Clock Cycles <sup>(3)</sup>	110	115	121	% $V_{OUT}$
$V_{UVSD}$	Under-Voltage Shutdown	16 Consecutive Clock Cycles <sup>(3)</sup>	68	73	78	% $V_{OUT}$
$V_{FLT}$	Fault Discharge Threshold	Measured at FB Pin		250		mV
$V_{FLT\_HYS}$	Fault Discharge Hysteresis	Measured at FB Pin ( $V_{FB} \sim 500$ mV)		250		mV
<b>Soft-Start</b>						
$t_{SS}$	$V_{OUT}$ to Regulation (T0.8)	$f_{SW}=500$ KHz		5.3		ms
$t_{EN}$	Fault Enable/SSOK (T1.0) <sup>(2)</sup>			6.7		ms

*Continued on the following page...*

## Electrical Specifications (Continued)

Electrical specifications are the result of using the circuit shown in Figure 1 with  $V_{IN}=12$  V, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
<b>Control Functions</b>						
$V_{EN}$	EN Threshold, Rising	$V_{CC}=5$ V		1.35	2.00	V
$V_{EN\_HYS}$	EN Hysteresis	$V_{CC}=5$ V		250		mV
$R_{EN}$	EN Pull-Up Resistance	$V_{CC}=5$ V		800		$\text{K}\Omega$
$I_{EN\_DISC}$	EN Discharge Current	Auto-Restart Mode, $V_{CC}=5$ V		1		$\mu\text{A}$
$R_{FBOK}$	FB OK Drive Resistance			800		$\Omega$
$V_{PGTH\_LO}$	PGOOD LOW Threshold	FB $< V_{REF}$ , 2 Consecutive Clock Cycles <sup>(3)</sup>	-14	-11	-8	$\%V_{REF}$
$V_{PGTH\_UP}$		FB $> V_{REF}$ , 2 Consecutive Clock Cycles <sup>(3)</sup>	+7.0	+10.0	+13.5	
$V_{PG\_LO}$	PGOOD Output Low	$I_{OUT} \leq 2$ mA			0.4	V
$I_{PG\_LK}$	PGOOD Leakage Current	$V_{PGOOD}=5$ V		0.2	1.0	$\mu\text{A}$

### Notes:

2. Specifications guaranteed by design and characterization; not production tested.
3. Delay times are not tested in production. Guaranteed by design.

## Typical Characteristics

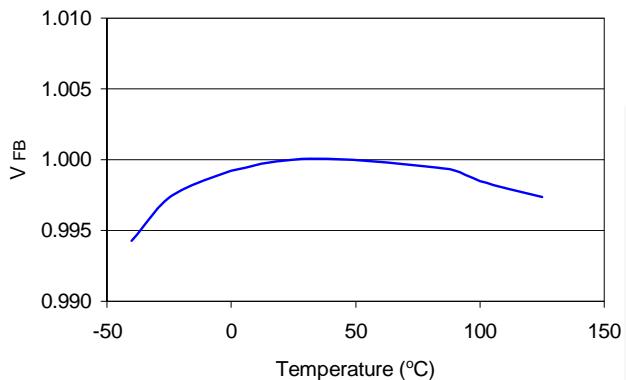


Figure 4. Reference Voltage ( $V_{FB}$ ) vs. Temperature, Normalized

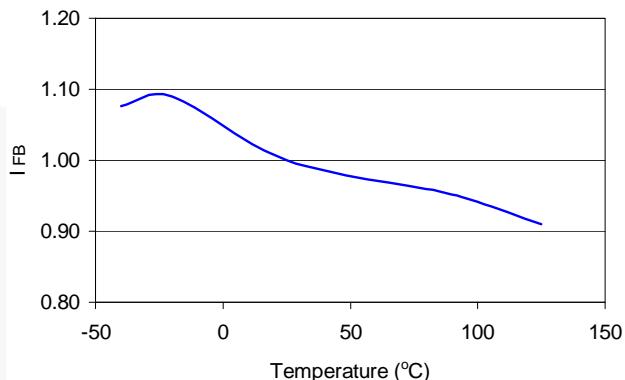


Figure 5. Reference Bias Current ( $I_{FB}$ ) vs. Temperature, Normalized

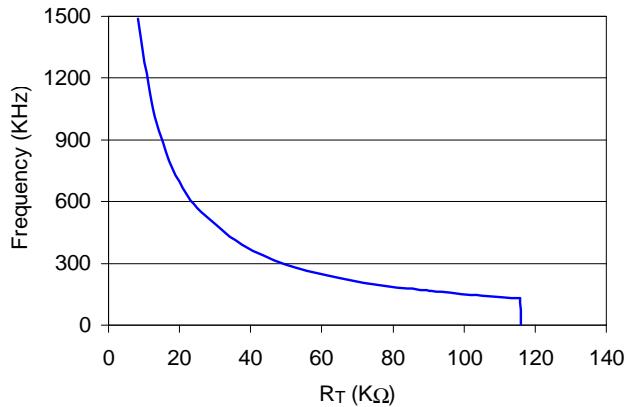


Figure 6. Frequency vs.  $R_T$

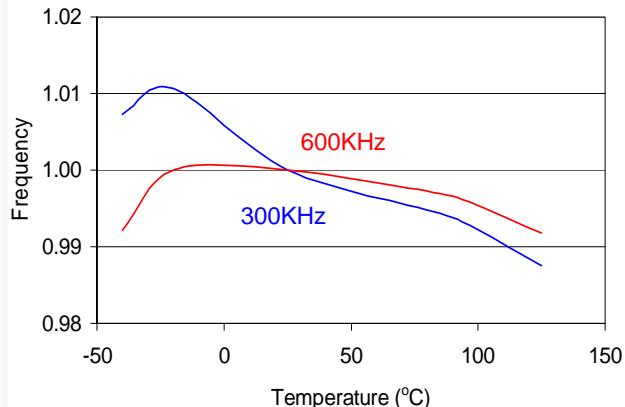


Figure 7. Frequency vs. Temperature, Normalized

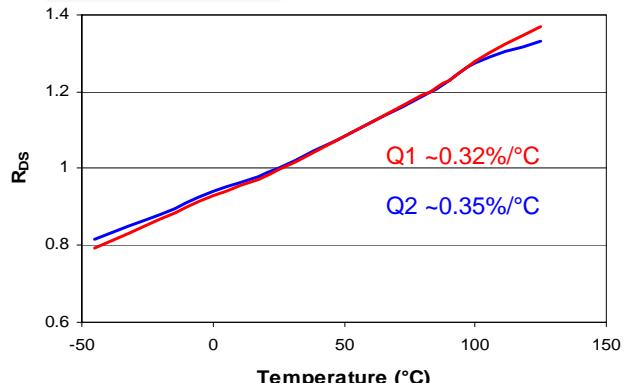


Figure 8.  $R_{DS}$  vs. Temperature, Normalized ( $V_{CC}=V_{GS}=5$  V), Figure 1

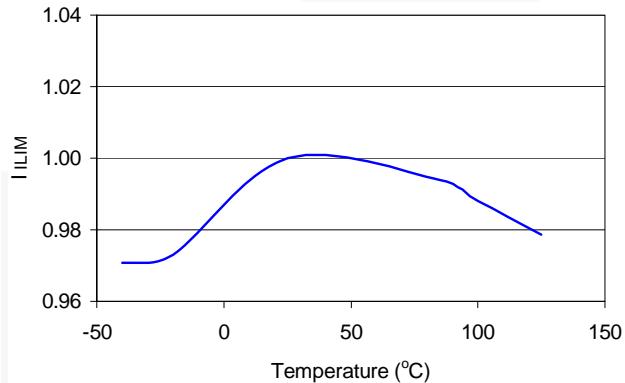


Figure 9.  $I_{LIM}$  Current ( $I_{ILIM}$ ) vs. Temperature, Normalized

## Application Circuits

FAN2110

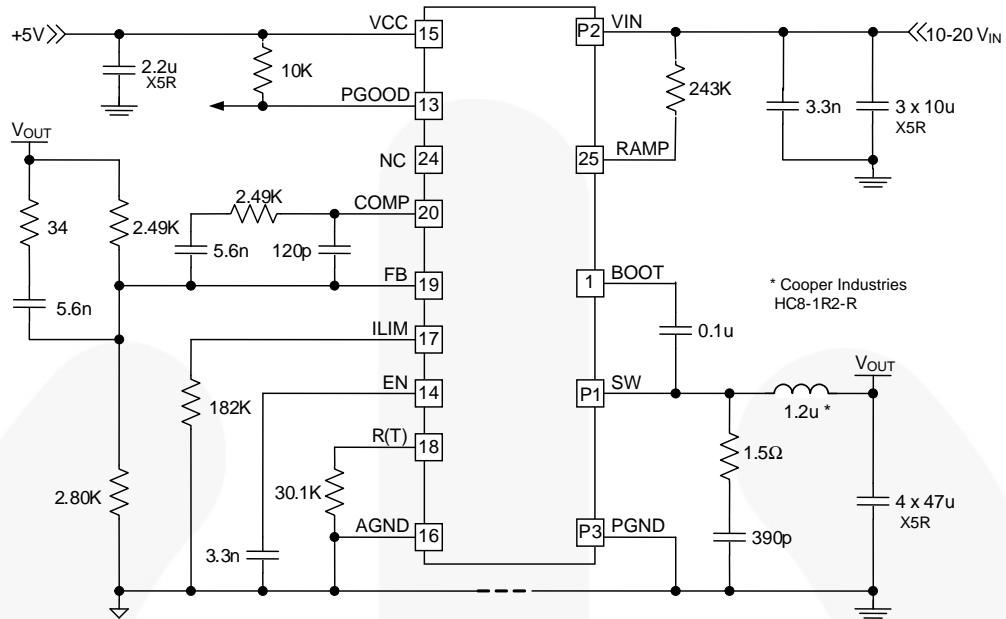


Figure 10. Application Circuit: 1.5 V<sub>OUT</sub>, 10 A, 500 KHz (10 V-20 V<sub>IN</sub>)

FAN2110

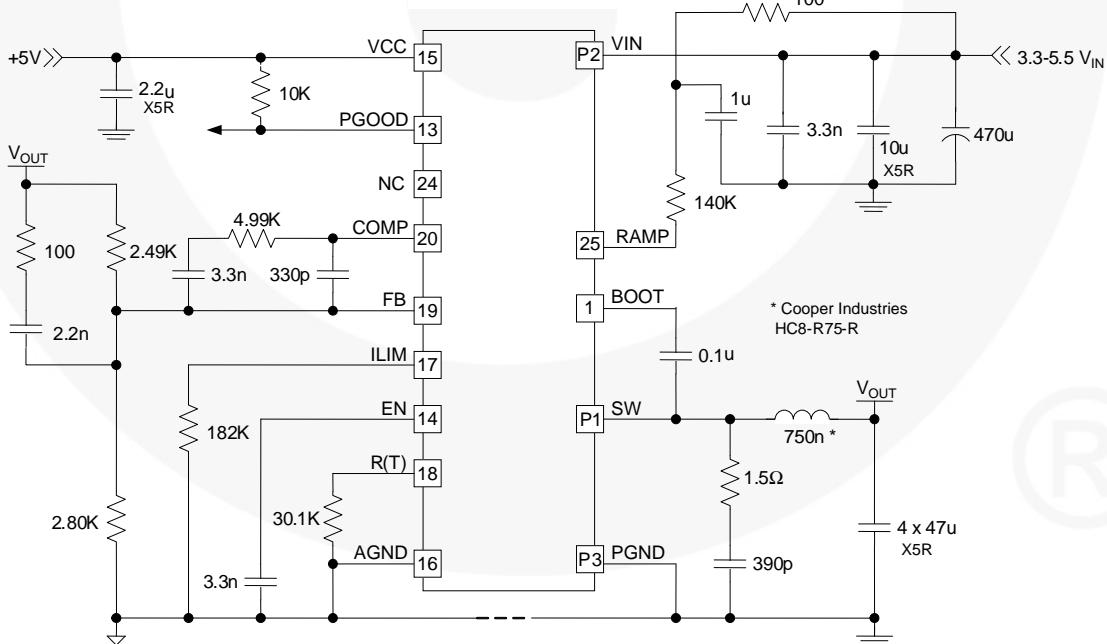


Figure 11. Application Circuit: 1.5 V<sub>OUT</sub>, 10 A, 500 KHz (3.3 V-5.5 V<sub>IN</sub>)

## Typical Performance Characteristics

Typical operating characteristics using the circuit in Figure 10.  $V_{IN}=12\text{ V}$ ,  $V_{CC}=5\text{ V}$ ,  $T_A=25^\circ\text{C}$ , unless otherwise specified.

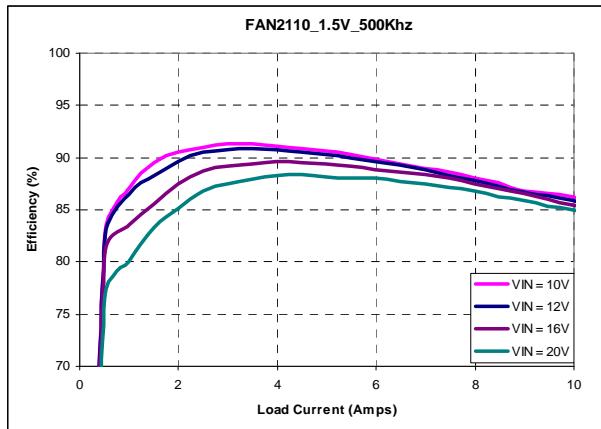


Figure 12.  $1.5\text{ V}_{OUT}$  Efficiency, 500 KHz

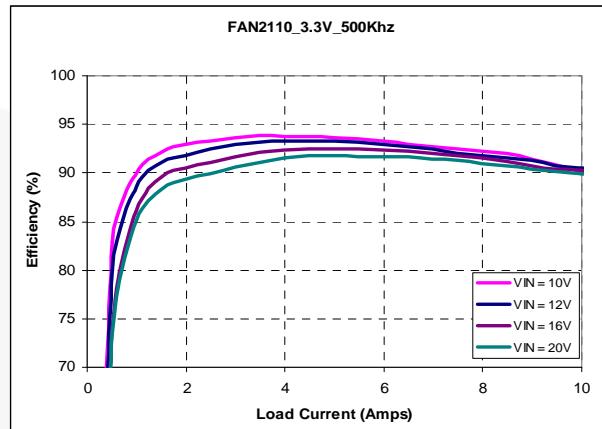


Figure 13.  $3.3\text{ V}_{OUT}$  Efficiency, 500 KHz<sup>(4)</sup>

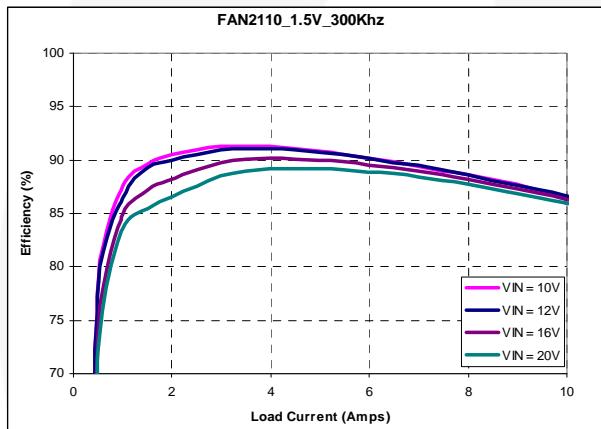


Figure 14.  $1.5\text{ V}_{OUT}$  Efficiency, 300 KHz

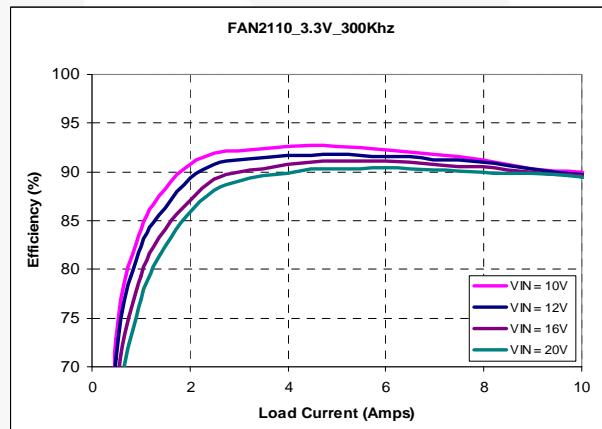


Figure 15.  $3.3\text{ V}_{OUT}$  Efficiency, 300 KHz<sup>(4)</sup>

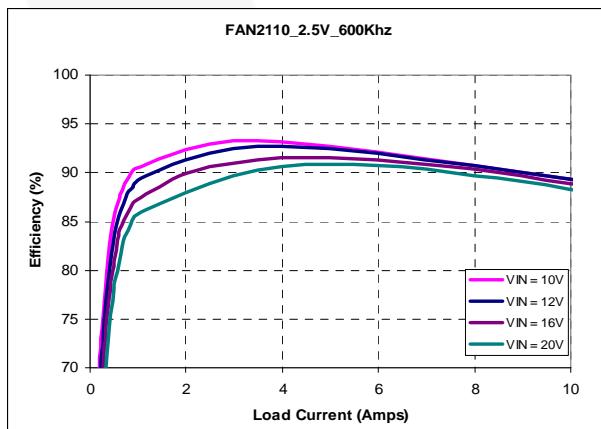


Figure 16.  $2.5\text{ V}_{OUT}$  Efficiency, 600 KHz<sup>(4)</sup>

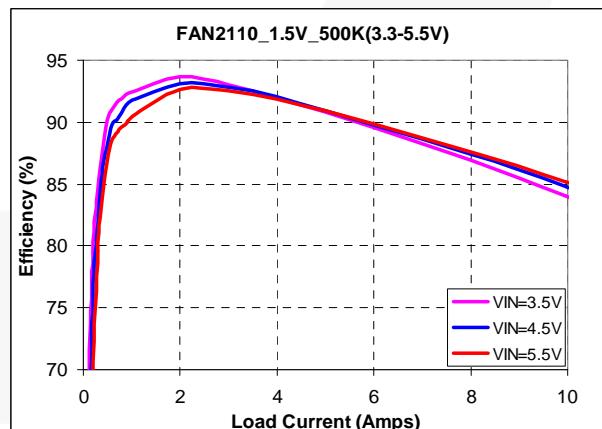


Figure 17.  $1.5\text{ V}_{OUT}$  Efficiency, 500 KHz  
( $V_{IN}=3.3\text{ V}$  to  $5\text{ V}$ ), Figure 11

**Note:**

4. Circuit values for this configuration change in Figure 10.

## Typical Performance Characteristics (Continued)

Typical operating characteristics using the circuit in Figure 10.  $V_{IN}=12$  V,  $V_{CC}=5$  V,  $T_A=25^\circ\text{C}$  unless otherwise specified.

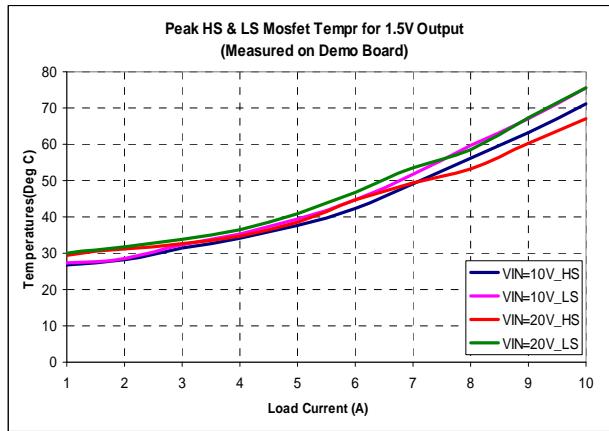


Figure 18. Peak MOSFET Temperatures, Figure 10

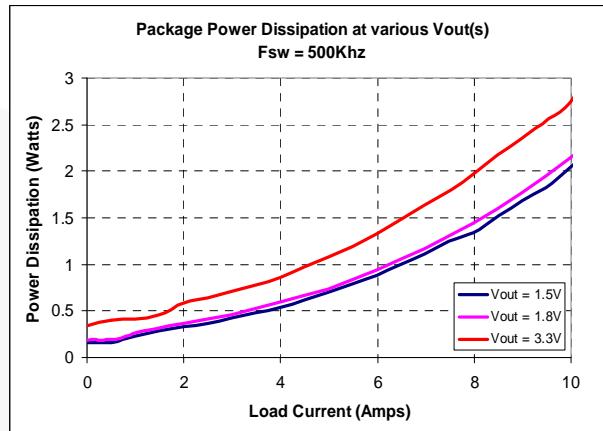


Figure 19. Device Dissipation Over  $V_{OUT}$  vs. Load

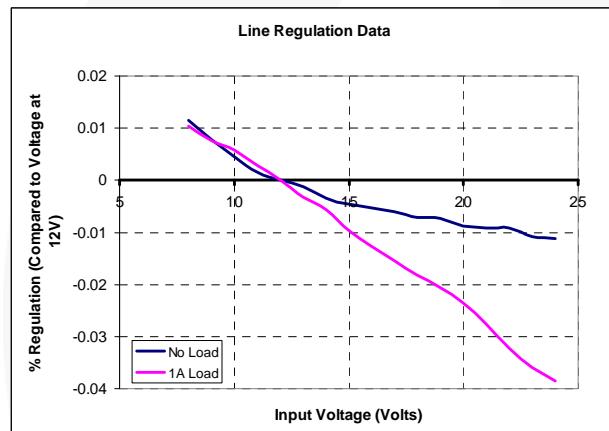


Figure 20.  $1.5\text{ V}_{OUT}$  Line Regulation

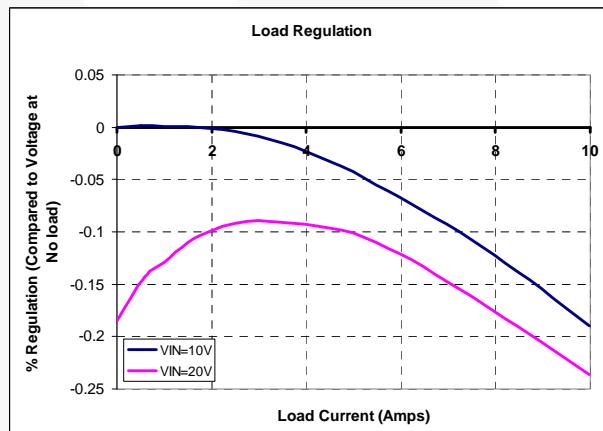


Figure 21.  $1.5\text{ V}_{OUT}$  Load Regulation

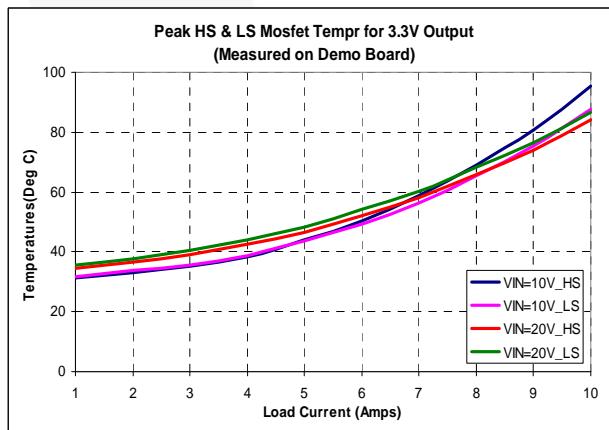


Figure 22. Peak MOSFET Temperatures, 3.3 V Output<sup>(5)</sup>

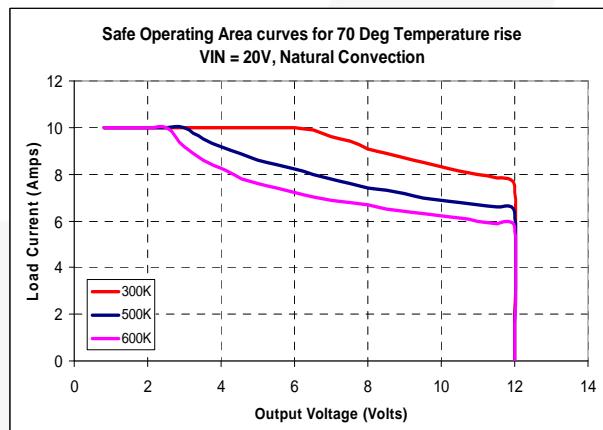


Figure 23. Typical  $20\text{ V}_{IN}$  Safe Operation Area (SOA),  $70^\circ\text{C}$  Ambient Temperature, Natural Convection

### Note:

- Circuit values for this configuration change in Figure 10.

## Typical Performance Characteristics (Continued)

Typical operating characteristics using the circuit in Figure 10.  $V_{IN}=12$  V,  $V_{CC}=5$  V,  $T_A=25^\circ\text{C}$  unless otherwise specified.

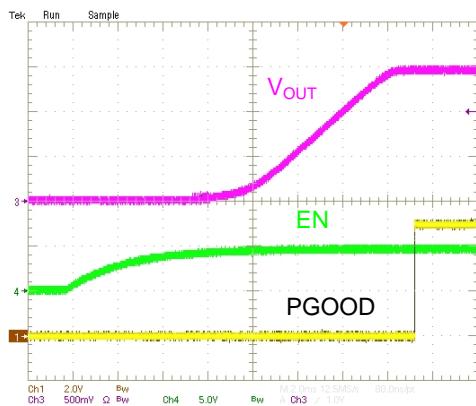


Figure 24. Startup, 10 A Load

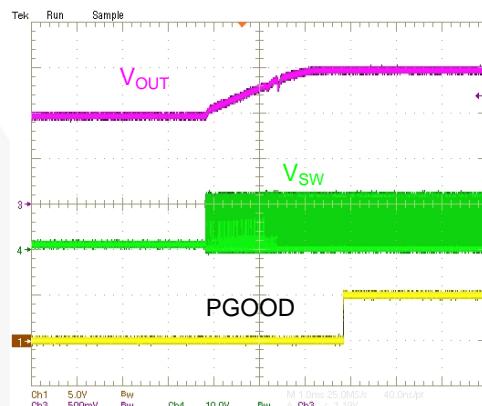


Figure 25. Startup with 1.0 V Pre-Bias on  $V_{OUT}$

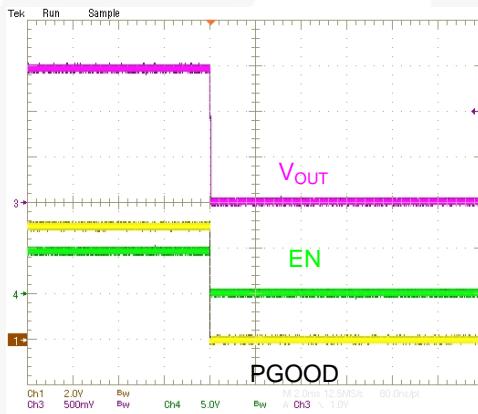


Figure 26. Shutdown, 10 A Resistive Load

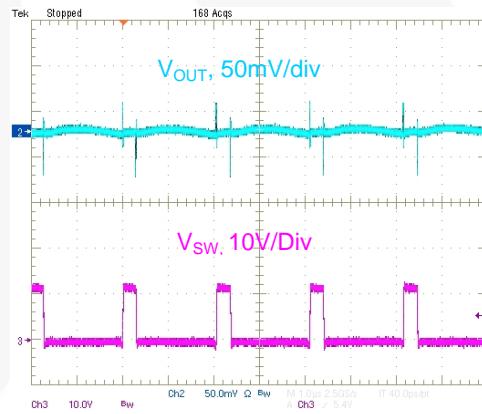


Figure 27.  $V_{OUT}$  Ripple and SW Voltage, 10 A Load

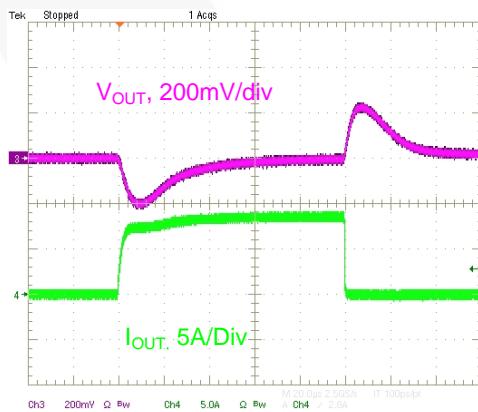


Figure 28. Transient Response, 0-8 A Load,  
5 A /  $\mu\text{s}$  Slew Rate

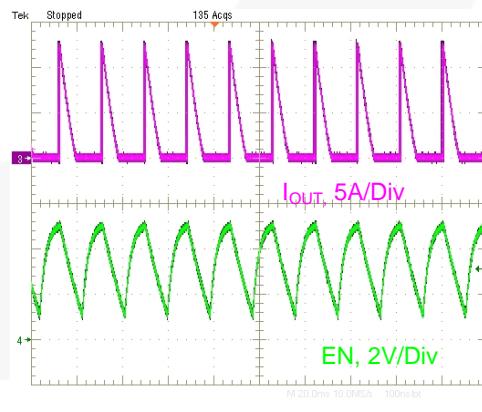


Figure 29. Restart on Short Circuit (Fault)

## Circuit Description

## PWM Generation

Refer to Figure 2 for the PWM control mechanism. FAN2110 uses the summing-mode method of control to generate the PWM pulses. An amplified current-sense signal is summed with an internally generated ramp and the combined signal is compared with the output of the error amplifier to generate the pulse width to drive the high-side MOSFET. Sensed current from the previous cycle is used to modulate the output of the summing block. The output of the summing block is also compared against a voltage threshold set by the  $R_{LIM}$  resistor to limit the inductor current on a cycle-by-cycle basis.  $R_{RAMP}$  resistor helps set the charging current for the internal ramp and provides input voltage feed-forward function. The controller facilitates external compensation for enhanced flexibility.

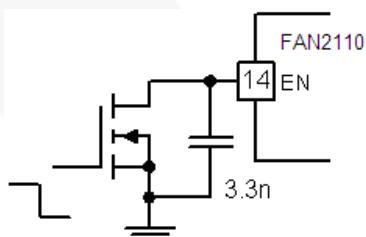
## Initialization

Once  $V_{CC}$  exceeds the UVLO threshold and EN is HIGH, the IC checks for a shorted FB pin before releasing the internal soft-start ramp (SS).

If the parallel combination of  $R_1$  and  $R_{BIAS}$  is  $\leq 1\text{ K}\Omega$ , the internal SS ramp is not released and the regulator does not start.

## Enable

FAN2110 has an internal pull-up to the enable (EN) pin so that the IC is enabled once  $V_{CC}$  exceeds the UVLO threshold. Connecting a small capacitor across EN and AGND delays the rate of voltage rise on the EN pin. The EN pin also serves for the restart whenever a fault occurs (*refer to the Auto-Restart section*). If the regulator is enabled externally, the external EN signal should go HIGH only after  $V_{CC}$  is established. For applications where such sequencing is required, FAN2110 can be enabled (after the  $V_{CC}$  comes up) with external control, as shown in Figure 30.



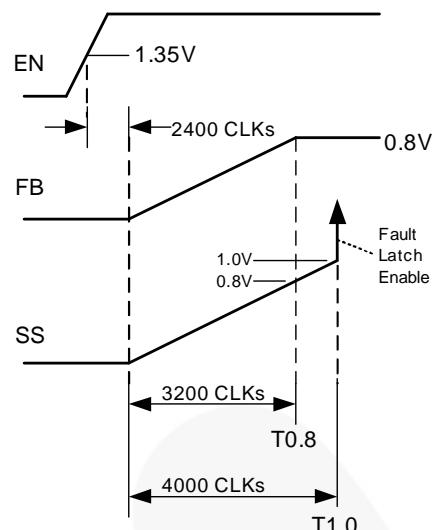
**Figure 30. Enabling with External Control**

## Soft-Start

Once internal SS ramp has charged to 0.8 V (T0.8), the output voltage is in regulation. Until SS ramp reaches 1.0 V (T1.0), the fault latch is inhibited.

To avoid skipping the soft-start cycle, it is necessary to apply  $V_{IN}$  before  $V_{CC}$  reaches its UVLO threshold. Normal sequence for powering up would be  $V_{IN} \rightarrow V_{CC} \rightarrow EN$ .

Soft-start time is a function of oscillator frequency.



**Figure 31. Soft-Start Timing Diagram**

$V_{CC}$  UVLO or toggling the EN pin discharges the internal SS and resets the IC. In applications where external EN signal is used,  $V_{IN}$  and  $V_{CC}$  should be established before the EN signal comes up to prevent skipping the soft-start function.

## Startup on Pre-Bias

The regulator does not allow the low-side MOSFET to operate in full synchronous mode until SS reaches 95% of  $V_{REF}$  (~0.76 V). This enables the regulator to startup on a pre-biased output and ensures that pre-biased outputs are not discharged during the soft-start cycle.

## Protections

The converter output is monitored and protected against extreme overload, short-circuit, over-voltage, under-voltage, and over-temperature conditions.

## Under-Voltage Shutdown

If voltage on the FB pin remains below the under-voltage threshold for 16 consecutive clock cycles, the fault latch is set and the converter shuts down. This protection is not active until the internal SS ramp reaches 1.0 V during soft-start.

## Over-Voltage Protection

If voltage on the FB pin exceeds 115% of  $V_{REF}$  for two consecutive clock cycles, the fault latch is set and shutdown occurs.

A shorted high-side MOSFET condition is detected when SW voltage exceeds  $\sim 0.7$  V while the low-side MOSFET is fully enhanced. The fault latch is set immediately upon detection.

The OV/UV fault protection circuits above are active all the time, including during soft-start.

## Over-Temperature Protection (OTP)

The chip incorporates an over-temperature protection circuit that sets the fault latch when a die temperature of about  $150^{\circ}\text{C}$  is reached. The IC restarts when the die temperature falls below  $125^{\circ}\text{C}$ .

## Auto-Restart

After a fault, EN pin is discharged by a  $1\text{ }\mu\text{A}$  current sink to a  $1.1$  V threshold before the internal  $800\text{ K}\Omega$  pull-up is restored. A new soft-start cycle begins when EN charges above  $1.35$  V.

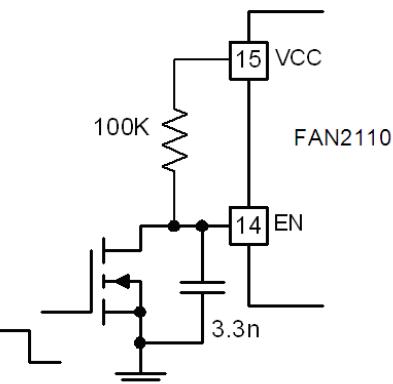
Depending on the external circuit, the FAN2110 can be configured to remain latched-off or to automatically restart after a fault.

**Table 1. Fault / Restart Configurations**

EN Pin	Controller / Restart State
Pull to GND	OFF (Disabled)
Pull-up to $V_{CC}$ with 100K	No Restart – Latched OFF (After $V_{CC}$ Comes Up)
Open	Immediate Restart After Fault
Cap. to GND	New Soft-Start Cycle After: $t_{DELAY}\text{ (ms)} = 3.9 \cdot C(\text{nf})$

When EN is left open, restart is immediate.

If auto-restart is not desired, tie the EN pin to the  $V_{CC}$  pin or pull it HIGH after  $V_{CC}$  comes up with a logic gate to keep the  $1\text{ }\mu\text{A}$  current sink from discharging EN to  $1.1$  V. Figure 32 shows one method to pull up EN to  $V_{CC}$  for a latch configuration.



**Figure 32. Enable Control with Latch Option**

## Power-Good (PGOOD) Signal

PGOOD is an open-drain output that asserts LOW when  $V_{out}$  is out of regulation, as measured at the FB pin. Thresholds are specified in the Electrical Specifications section. PGOOD does not assert HIGH until the fault latch is enabled (T1.0) (see Figure 31).

## Application Information

### Bias Supply

The FAN2110 requires a 5 V supply rail to bias the IC and provide gate-drive energy. Connect a  $\geq 2.2 \mu\text{F}$  X5R or X7R decoupling capacitor between VCC and AGND.

Since V<sub>CC</sub> is used to drive the internal MOSFET gates, supply current is frequency and voltage dependent. Approximate V<sub>CC</sub> current (I<sub>CC</sub>) is calculated by:

$$I_{CC(\text{mA})} = 4.58 + \left[ \left( \frac{V_{CC} - 5}{227} + 0.013 \right) \cdot (f - 128) \right] \quad (1)$$

where frequency (f) is expressed in KHz.

### Setting the Output Voltage

The output voltage of the regulator can be set from 0.8V to 80% of V<sub>IN</sub> by an external resistor divider (R<sub>1</sub> and R<sub>BIAS</sub> in Figure 1). For output voltages >3.3V, output current rating may need to be de-rated depending on the ambient temperature, power dissipated in the package and the PCB layout. (Refer to *Thermal Information table* on page 4, Figure 22, and Figure 23.)

The external resistor divider is calculated using:

$$\frac{0.8V}{R_{BIAS}} = \frac{V_{OUT} - 0.8V}{R_1} + 650\text{nA} \quad (2)$$

Connect R<sub>BIAS</sub> between FB and AGND.

If R<sub>1</sub> is open (see Figure 1), the output voltage is not regulated and a latched fault occurs after the SS is complete (T1.0).

If the parallel combination of R<sub>1</sub> and R<sub>BIAS</sub> is  $\leq 1\text{K}\Omega$ , the internal SS ramp is not released and the regulator does not start.

### Setting the Clock Frequency

Oscillator frequency is determined by an external resistor, R<sub>T</sub>, connected between the R<sub>T</sub> pin and AGND. Resistance is calculated by:

$$R_T(\text{K}\Omega) = \frac{(10^6 / f) - 135}{65} \quad (3)$$

where R<sub>T</sub> is in K $\Omega$  and frequency (f) is in KHz.

The regulator cannot start if R<sub>T</sub> is left open.

### Calculating the Inductor Value

Typically the inductor value is chosen based on ripple current ( $\Delta I_L$ ), which is chosen between 10 to 35% of the maximum DC load. Regulator designs that require fast transient response use a higher ripple-current setting, while regulator designs that require higher efficiency keep ripple current on the low side and

operate at a lower switching frequency. The inductor value is calculated by the following formula:

$$L = \frac{V_{OUT} \cdot (1 - \frac{V_{OUT}}{V_{IN}})}{\Delta I_L \cdot f} \quad (4)$$

where f is the oscillator frequency.

### Setting the Ramp Resistor Value

R<sub>RAMP</sub> resistor plays a critical role in the design by providing charging current to the internal ramp capacitor and also serving as a means to provide input voltage feedforward.

R<sub>RAMP</sub> is calculated by the following formula:

$$R_{RAMP(\text{K}\Omega)} = \frac{(V_{IN} - 1.8) \cdot V_{OUT}}{(31 - 2.05 \cdot I_{OUT}) \cdot V_{IN} \cdot f \cdot 10^{-6}} - 2 \quad (5)$$

where frequency (f) is expressed in KHz.

For wide input operation, first calculate R<sub>RAMP</sub> for the minimum and maximum input voltage conditions and use larger of the two values calculated.

In all applications, current through the R<sub>RAMP</sub> pin must be greater than 10  $\mu\text{A}$  from the equation below for proper operation:

$$\frac{V_{IN} - 1.8}{R_{RAMP} + 2} \geq 10\mu\text{A} \quad (6)$$

If the calculated R<sub>RAMP</sub> values in Equation (5) result in a current less than 10  $\mu\text{A}$ , use the R<sub>RAMP</sub> value that satisfies Equation (6). In applications with large Input ripple voltage, the R<sub>RAMP</sub> resistor should be adequately decoupled from the input voltage to minimize ripple on the ramp pin. For example, see Figure 11.

### Setting the Current Limit

The current limit system involves two comparators. The MAX I<sub>LIMIT</sub> comparator is used with a V<sub>ILIM</sub> fixed-voltage reference and represents the maximum current limit allowable. This reference voltage is temperature compensated to reflect the R<sub>DSON</sub> variation of the low-side MOSFET. The ADJUST I<sub>LIMIT</sub> comparator is used where the current limit needs to be set lower than the V<sub>ILIM</sub> fixed reference. The 10  $\mu\text{A}$  current source does not track the R<sub>DSON</sub> changes over temperature, so change is added into the equations for calculating the ADJUST I<sub>LIMIT</sub> comparator reference voltage, as is shown below. Figure 33 shows a simplified schematic of the over-current system.

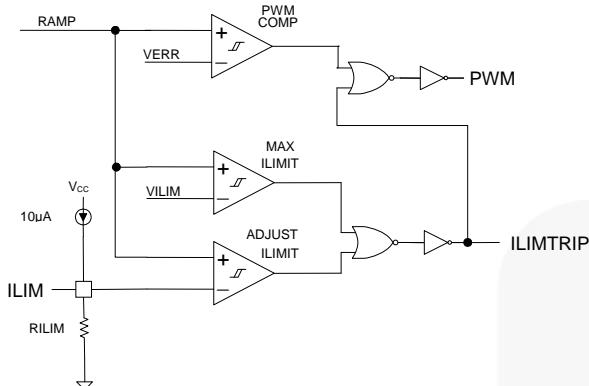


Figure 33. Current-Limit System Schematic

Since the  $I_{LIM}$  voltage is set by a 10  $\mu$ A current source into the  $R_{RILIM}$  resistor, the basic equation for setting the reference voltage is:

$$V_{RILIM} = 10\mu\text{A} \cdot R_{RILIM} \quad (7)$$

To calculate  $R_{RILIM}$ :

$$R_{RILIM} = V_{RILIM} / 10\mu\text{A} \quad (8)$$

The voltage  $V_{RILIM}$  is made up of two components,  $V_{BOT}$  (which relates to the current through the low-side MOSFET) and  $V_{RMPEAK}$  (which relates to the peak current through the inductor). Combining those two voltage terms results in:

$$R_{RILIM} = (V_{BOT} + V_{RMPEAK}) / 10\mu\text{A} \quad (9)$$

$$R_{RILIM} = \{0.96 + (I_{LOAD} \cdot R_{DSON} \cdot K_T \cdot 8) + \{D \cdot (V_{IN} - 1.8) / (f_{SW} \cdot 0.03 \cdot 10^3 \cdot 3 \cdot R_{RAMP})\} / 10\mu\text{A} \quad (10)$$

where:

$$V_{BOT} = 0.96 + (I_{LOAD} \cdot R_{DSON} \cdot K_T \cdot 8);$$

$$V_{RMPEAK} = D \cdot (V_{IN} - 1.8) / (f_{SW} \cdot 0.03 \cdot 10^3 \cdot 3 \cdot R_{RAMP});$$

$I_{LOAD}$  = the desired maximum load current;

$R_{DSON}$  = the nominal  $R_{DSON}$  of the low-side MOSFET;

$K_T$  = the normalized temperature coefficient for the low-side MOSFET (on datasheet graph);

$D = V_{OUT} / V_{IN}$  duty cycle;

$f_{SW}$  = Clock frequency in kHz; and

$R_{RAMP}$  = chosen ramp resistor value in  $\text{k}\Omega$ .

After 16 consecutive, pulse-by-pulse, current-limit cycles, the fault latch is set and the regulator shuts down. Cycling  $V_{CC}$  or EN restores operation after a normal soft-start cycle (refer to the Auto-Restart section).

The over-current protection fault latch is active during the soft-start cycle. Use 1% resistor for  $R_{RILIM}$ .

Always use an external resistor  $R_{RILIM}$  to set the current limit at the desired level. When  $R_{RILIM}$  is not connected,

the IC's internal default current limit is fairly high. This could lead to operation at high load currents, causing overheating of the regulator. For a given  $R_{RILIM}$  and  $R_{RAMP}$  setting, the current limit point varies slightly in an inverse relationship with respect to input voltage ( $V_{IN}$ ).

### Loop Compensation

The loop is compensated using a feedback network around the error amplifier. Figure 34 shows a complete type-3 compensation network. For type-2 compensation, eliminate  $R_3$  and  $C_3$ .

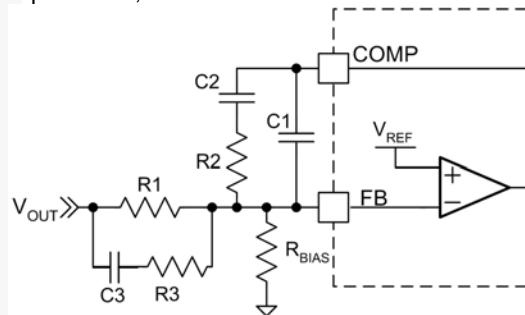


Figure 34. Compensation Network

Since the FAN2110 employs summing current-mode architecture, type-2 compensation can be used for many applications. For applications that require wide loop bandwidth and/or use very low-ESR output capacitors, type-3 compensation may be required.

$R_{RAMP}$  also provides feedforward compensation for changes in  $V_{IN}$ . With a fixed  $R_{RAMP}$  value, the modulator gain increases as  $V_{IN}$  is reduced, which could make it difficult to compensate the loop. For low-input-voltage-range designs (3 V to 8 V),  $R_{RAMP}$  and the compensation component values are different compared to designs with  $V_{IN}$  between 8 V and 24 V.

### Recommended PCB Layout

Good PCB layout and careful attention to temperature rise is essential for reliable operation of the regulator. Four-layer PCB with two-ounce copper on the top and bottom side and thermal vias connecting the layers is recommended. Keep power traces wide and short to minimize losses and ringing. Do not connect AGND to PGND below the IC. Connect the AGND pin to PGND at the output OR to the PGND plane.

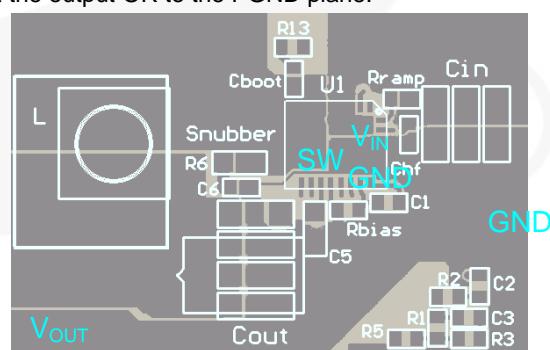
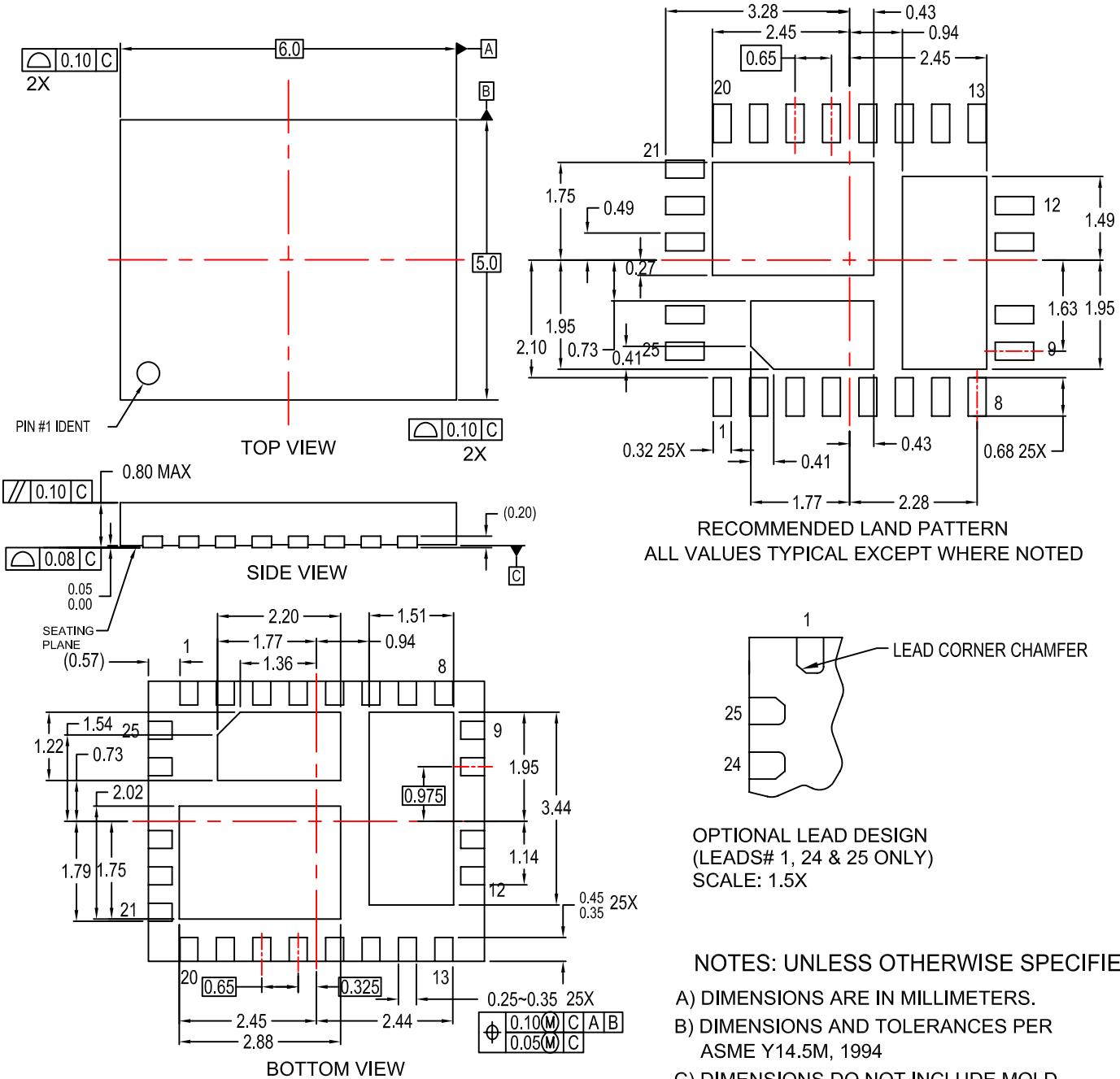


Figure 35. Recommended PCB Layout

REVISIONS			
LTR	DESCRIPTION	DATE	BY/SITE
1	RELEASE TO DOCUMENT CONTROL	12-JUL-2007	J.Chan/FSPM
2	ADDED DIMENSIONS TO BOTTOM VIEW AND LANDPATTERN RECOMMENDATION	7-SEPT-2007	H.ALLEN/FSME
3	CHAMFERED LANDPATTERN PAD 1	17-JUN-2009	H.ALLEN/FSME



APPROVALS	DATE	FAIRCHILD SEMICONDUCTOR		
DRAWN H.ALLEN	7-SEPT-07	Bayan Lepas, FIZ, 11900, Penang, Malaysia.		
DFTG. CHK. S.MARTIN	7-SEPT-07			
ENGR. CHK.				
PROJECTION	SCALE	SIZE	DRAWING NUMBER	REV
	N/A	N/A	MKT-MLP25A	3
	INCH (MM)		DO NOT SCALE DRAWING	SHEET 1 OF 1



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